

	(X)Original () Supplem		· /	() Desig				
that I verily believe that I am the inventors are named below) of the	original, first and sole invente	or (if only one name is	listed below)	or an orig	ginal, fi	rst and join	it inventor (i	/ name f plura
Title: SUBSTRATE PC	LISHING APPARA	TUS						
of which is described and claime	ed in:							
() the attached specification, or								
(Xthe specification in the applic	ation Serial No.		filed_	July 1	14,	2003	;	
and with amendments through	gh	· (if a	oplicable), or	•				
() the specification in Internation	nal Application No. PCT/		, filed			, and as a	mended	
on								

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
JAPAN	2003-138479	May 16, 2003	Yes
JAPAN	2003-138496	May 16, 2003	Yes
JAPAN .	2003-138782	May 16, 2003	Yes

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Jeffrey R. Filipek, Reg. No. 41,471, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from WATANABE & HOTTA

as to any action to be taken in the U.S.

Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

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The above app	lication may be more	particularly identified as follows	3:	
U.S. Application	on Serial No		Filing Date	
Applicant Reference Number		Atty Docket No.		
Title of Inventi	on	· · · · · · · · · · · · · · · · · · ·		
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